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PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2675264

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
OLIVER J. KIERSE	12/05/2013
FRANK POUCHER	11/18/2013
MICHAEL J. CUSACK	12/05/2013
PADRAIG L. FITZGERALD	12/04/2013
PATRICK ELEBERT	11/18/2013

RECEIVING PARTY DATA

Name:	ANALOG DEVICES TECHNOLOGY	
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City:	HAMILTON	
State/Country:	BERMUDA	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14072572

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	ADIRE.085A
NAME OF SUBMITTER:	PAUL STELLMAN

PATENT 502628656 REEL: 031933 FRAME: 0193

Signature:	/Paul Stellman/
Date:	01/09/2014
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 7 source=ADIRE.085A decl#page1.tif source=ADIRE.085A decl#page2.tif source=ADIRE.085A decl#page3.tif source=ADIRE.085A decl#page4.tif source=ADIRE.085A decl#page5.tif source=ADIRE.085A decl#page5.tif source=ADIRE.085A decl#page6.tif source=ADIRE.085A decl#page7.tif	

Application Data Sheet filed previously or concurrently

Docket No.: ADIRE.085A Page 1 of 7

Title: STRESS SHIELD FOR INTEGRATED CIRCUIT PACKAGE

Inventors: Oliver J. Kierse, Frank Poucher, Michael J. Cusack, Padraig L. Fitzgerald, and Patrick Elebert

Declaration

This Declaration is directed to the application identified above that:

Was filed **November 5, 2013** as U.S. or International Application No. 14/072,572, and incorporating any amendments made thereto prior to the signature date of this Declaration.

As a named inventor, I declare that:

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims, as amended by any amendment.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.

Assignment from Inventors

WHEREAS, above-identified inventors (individual(s) hereinafter "ASSIGNOR") invented certain new and useful improvements, technology, inventions, developments, ideas, ornamental designs, or discoveries, and hereby assign or are under an obligation to assign to the below identified Assignee the above-titled application (collectively hereinafter referred to as the "Work") for which an application for Letters Patent in the United States (identified above) has been prepared for filing with the United States Patent and Trademark Office (hereinafter the "Application").

AND WHEREAS, **ANALOG DEVICES TECHNOLOGY**, with its principal place of business at 3rd Floor, Par La Ville Place 14, Par La Ville Road, HAMILTON, BERMUDA (hereinafter the "ASSIGNEE"), desires to acquire the entire right, title, and interest in and to the Application and the Work.

NOW, THEREFORE, for good and valuable consideration of which receipt is hereby acknowledged, ASSIGNOR hereby acknowledges that ASSIGNOR has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in the Application and the Work, including all patent properties filed or issued upon the Application and the Work; where "Patent Properties" include, but are not limited to:

all provisional applications relating thereto;

all nonprovisional applications claiming priority to aforementioned provisional(s) and/or the present Application, including, all divisions, continuations, continuations-in-part, and reissues, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof; and

all rights of priority under International Conventions and any related Letters Patent which may hereafter be granted or filed in any country or countries foreign to the United States, all extensions, renewals and reissues thereof.

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Title: STRESS SHIELD FOR INTEGRATED CIRCUIT PACKAGE

Inventors: Oliver J. Kierse, Frank Poucher, Michael J. Cusack, Padraig L. Fitzgerald, and Patrick Elebert

ASSIGNOR hereby acknowledges the ASSIGNEE as the Applicant for all aforementioned patent properties, and authorizes and requests the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all related Letters Patent to the ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR DOES HEREBY sell, assign, transfer, and convey to ASSIGNEE, its successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of said Letters Patent before or after issuance.

AND ASSIGNOR DOES HEREBY covenant and agree that ASSIGNOR will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to ASSIGNOR respecting the Work, and testify in any legal proceeding, assist in the preparation of any other Patent Property relating to the Application and the Work or any improvements made thereto, sign/execute all lawful papers, authorize the filing of and execute and make all rightful oaths and/or declarations in connection with the Application and the Work including any improvements made thereto, any patent applications filed therefrom, and any continuing application filed from any of the aforementioned applications, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for the Work in all countries.

COMBINED DECLARATION & ASSIGNMENT (37 CFR 1.63(e)) Application Data Sheet filed previously or concurrently Docket No.: ADIRE.085A Page 3 of 7 Title: STRESS SHIELD FOR INTEGRATED CIRCUIT PACKAGE Inventors: Oliver J. Kierse, Frank Poucher, Michael J. Cusack, Padraig L. Fitzgerald, and Patrick Elebert

Signature:

Witnessed by:

Witness Name (printed):

Date: 5/11/13

Date: 5/11/13

COMBINED DECLARATION & ASSIGNMENT (37 CFR 1.63(e)) Application Data Sheet filed previously or concurrently				
Docket No.: ADIRE.085A	Page 4 of 7			
Title: STRESS SHIELD FOR INTEGRATED CIRCUIT PACKAGE				
Inventors: Oliver J. Kierse, Frank Poucher, Michael J. Cusack, Padraig L. Fitzgerald, and Patrick Elebert				
Legal Name of inventor: Frank Poucher				
Signature: Trade Parker Date: _	18/11/2013			
Witnessed by: Fallet Webb				
Witness Name (printed) PATRICK FLITCHT				

Application Data Sheet filed previously or concurrently

Docket No.: ADIRE.085A

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Title: STRESS SHIELD FOR INTEGRATED CIRCUIT PACKAGE

Inventors: Oliver J. Kierse, Frank Poucher, Michael J. Cusack, Padraig L. Fitzgerald, and Patrick Elebert

Legal Name of inventor: Michael J. Cusack

Signature: //

Date:

Witnessed by:

Witness Name (printed):

Application Data Sheet filed previously or concurrently

Docket No.: ADIRE.085A

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Title: STRESS SHIELD FOR INTEGRATED CIRCUIT PACKAGE

Inventors: Oliver J. Kierse, Frank Poucher, Michael J. Cusack, Padraig L. Fitzgerald, and Patrick Elebert

Legal Name of inventor: Padraig L. Fitzgerald

Signature:

Date: 4//2/20/3

Witnessed by: Witness Name (printed):

FRAME POUCHER.

COMBINED DECLARATION & ASSIGNMENT (37 CFR 1.63(e)) Application Data Sheet filed previously or concurrently Docket No.: ADIRE.085A Page 7 of 7 Title: STRESS SHIELD FOR INTEGRATED CIRCUIT PACKAGE Inventors: Oliver J. Kierse, Frank Poucher, Michael J. Cusack, Padraig L. Fitzgerald, and Patrick Elebert Legal Name of inventor: Patrick Elebert Signature: Pakek Melbert Date: 18-NW-2013 Witnessed by: Fackage

Witness Name (printed):

FRANK POYCHEN

16606330 110513

> PATENT REEL: 031933 FRAME: 0201

RECORDED: 01/09/2014